V30DL50C-M3, V30DL50CHM3

Vishay General Semiconductor

COMPLIANT

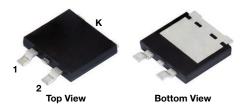
HALOGEN

FREE

Dual Trench MOS Barrier Schottky Rectifier

Ultra Low $V_F = 0.29 \text{ V}$ at $I_F = 5 \text{ A}$

TMBS® eSMP® Series TO-263AC (SMPD)





PRIMARY CHARACTERISTICS				
I _{F(AV)}	2 x 15 A			
V_{RRM}	50 V			
I _{FSM}	300 A			
V _F at I _F = 15 A	0.42 V			
T _J max.	150 °C			
Package	TO-263AC (SMPD)			
Diode variations	Dual common cathode			

FEATURES

- Trench MOS Schottky technology
- Very low profile typical height of 1.7 mm
- · Ideal for automated placement
- · Low forward voltage drop, low power losses
- · High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection.

MECHANICAL DATA

Case: TO-263AC (SMPD)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and

commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Base P/NHM3_X - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,....)

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: as marked

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)					
PARAMETER		SYMBOL	V30DL50C	UNIT	
Maximum repetitive peak reverse voltage		V _{RRM}	50	V	
Maximum average forward rectified current (fig. 1)	per device	I _{F(AV)}	30	^	
	per diode		15	A	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load		I _{FSM}	300	А	
Operating junction and storage temperature range		T _J , T _{STG}	-40 to +150	°C	



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage per diode	I _F = 5 A	T _A = 25 °C	V _F (1)	0.39	-	V	
	I _F = 7.5 A			0.42	-		
	I _F = 15 A			0.49	0.57		
	I _F = 5 A	T _A = 125 °C		0.29	-		
	I _F = 7.5 A			0.33	-		
	I _F = 15 A			0.42	0.50		
Reverse current per diode	V 50 V	$V_R = 50 \text{ V}$ $T_A = 25 \text{ °C}$ $T_A = 125 \text{ °C}$	I _R ⁽²⁾	-	1800	μA	
	v _R = 50 v			25	60	mA	
Typical junction capacitance	4.0 V, 1 MHz	T _A = 25 °C	СЈ	2800	-	pF	

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER		SYMBOL	V30DL50C	UNIT	
	per diode	R _{θJC}	1.7		
Typical thermal resistance	per device		0.9	°C/W	
	per device	R ₀ JA (1)(2)	45]	

Notes

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient: dP_D/dT_J < 1/R_{0,JA}
- (2) Free air, without heatsink

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
V30DL50C-M3/I	0.55	I	2000/reel	13" diameter plastic tape and reel		
V30DL50CHM3/I (1)	0.55	1	2000/reel	13" diameter plastic tape and reel		
V30DL50CHM3_A/I (1)	0.55	I	2000/reel	13" diameter plastic tape and reel		

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

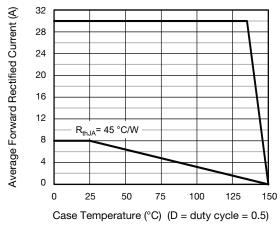


Fig. 1 - Forward Current Derating Curve

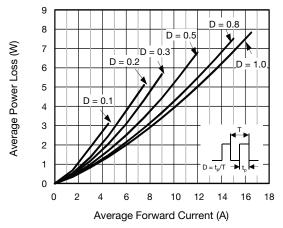


Fig. 2 - Forward Power Loss Characteristics Per Diode





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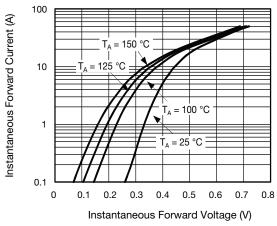


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

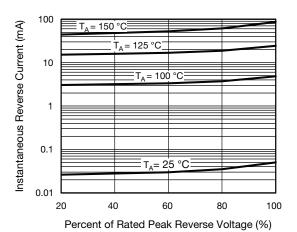


Fig. 4 - Typical Reverse Characteristics Per Diode

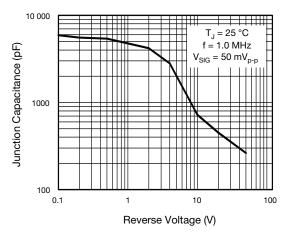


Fig. 5 - Typical Junction Capacitance Per Diode

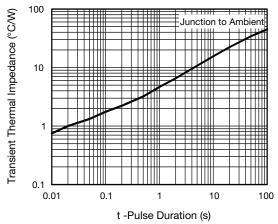


Fig. 6 - Typical Transient Thermal Impedance Per Device

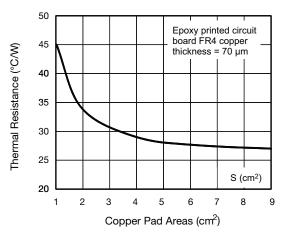


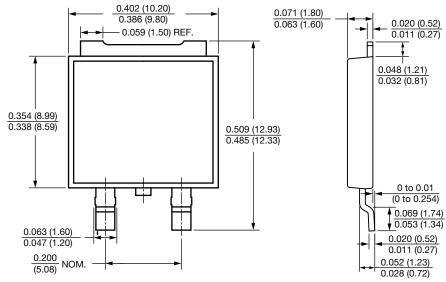
Fig. 7 - Thermal Resistance Junction-to-Ambient vs. Copper Pad Areas



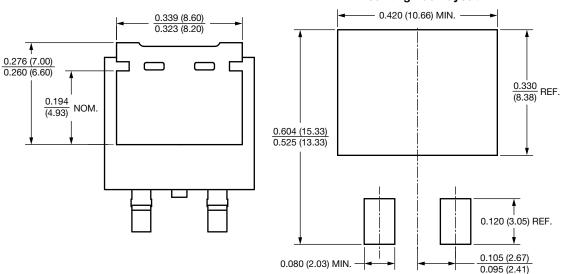
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

TO-263AC (SMPD)



Mounting Pad Layout





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